



RF Power Field Effect Transistors

N-Channel Enhancement-Mode Lateral MOSFETs

RF power transistors designed for applications operating at frequencies from 900 to 1215 MHz. These devices are suitable for use in defense and commercial pulse applications, such as IFF and DME.

- Typical Pulse Performance: $V_{DD} = 50$ Vdc, $I_{DQ} = 100$ mA, $P_{out} = 275$ W Peak (27.5 Watts Avg.), $f = 1030$ MHz, Pulse Width = 128 μ sec, Duty Cycle = 10%
Power Gain — 20.3 dB
Drain Efficiency — 65.5%
- Capable of Handling 10:1 VSWR, @ 50 Vdc, 1030 MHz, 275 W Peak Power
- Typical Broadband Performance: $V_{DD} = 50$ Vdc, $I_{DQ} = 100$ mA, $P_{out} = 250$ W Peak (25 Watts Avg.), $f = 960\text{--}1215$ MHz, Pulse Width = 128 μ sec, Duty Cycle = 10%
Power Gain — 19.8 dB
Drain Efficiency — 58%

Features

- Characterized with Series Equivalent Large-Signal Impedance Parameters
- Internally Matched for Ease of Use
- Qualified Up to a Maximum of 50 V_{DD} Operation
- Integrated ESD Protection
- Greater Negative Gate-Source Voltage Range for Improved Class C Operation
- In Tape and Reel. R5 Suffix = 50 Units, 56 mm Tape Width, 13-inch Reel.

MMRF1008HR5
MMRF1008HSR5

960-1215 MHz, 275 W, 50 V
PULSE
LATERAL N-CHANNEL
RF POWER MOSFETs

NI-780H-2L
MMRF1008HR5

NI-780S-2L
MMRF1008HSR5

Table 1. Maximum Ratings

| Rating | Symbol | Value | Unit |
|------------------------------------|-----------|-------------|------|
| Drain-Source Voltage | V_{DSS} | -0.5, +100 | Vdc |
| Gate-Source Voltage | V_{GS} | -6.0, +10 | Vdc |
| Storage Temperature Range | T_{stg} | -65 to +150 | °C |
| Case Operating Temperature | T_C | 150 | °C |
| Operating Junction Temperature (1) | T_J | 225 | °C |

Table 2. Thermal Characteristics

| Characteristic | Symbol | Value (2) | Unit |
|---|-----------------|-----------|------|
| Thermal Resistance, Junction to Case Case Temperature 80°C, 275 W Peak 128 μ sec Pulse Width, 10% Duty Cycle | $Z_{\theta JC}$ | 0.08 | °C/W |

- Continuous use at maximum temperature will affect MTTF.
- Refer to AN1955, *Thermal Measurement Methodology of RF Power Amplifiers*. Go to <http://www.freescale.com/rf>. Select Documentation/Application Notes - AN1955.

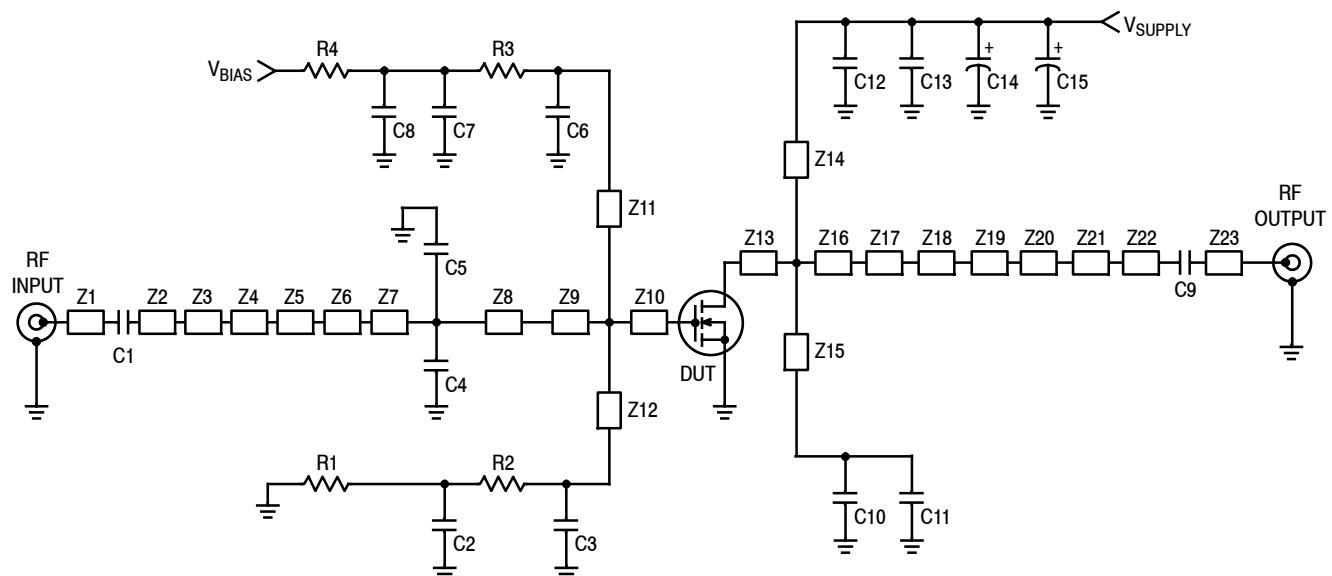
Table 3. ESD Protection Characteristics

| Test Methodology | Class |
|---------------------------------------|-------|
| Human Body Model (per JESD22-A114) | 2 |
| Machine Model (per EIA/JESD22-A115) | B |
| Charge Device Model (per JESD22-C101) | IV |

Table 4. Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|---|---------------------|-----|------|-----|-----------------|
| Off Characteristics | | | | | |
| Gate-Source Leakage Current ($V_{GS} = 5 \text{ Vdc}$, $V_{DS} = 0 \text{ Vdc}$) | I_{GSS} | — | — | 10 | μAdc |
| Drain-Source Breakdown Voltage ($V_{GS} = 0 \text{ Vdc}$, $I_D = 100 \text{ mA}$) | $V_{(BR)DSS}$ | 110 | — | — | Vdc |
| Zero Gate Voltage Drain Leakage Current ($V_{DS} = 50 \text{ Vdc}$, $V_{GS} = 0 \text{ Vdc}$) | I_{DSS} | — | — | 10 | μAdc |
| Zero Gate Voltage Drain Leakage Current ($V_{DS} = 90 \text{ Vdc}$, $V_{GS} = 0 \text{ Vdc}$) | I_{DSS} | — | — | 100 | μAdc |
| On Characteristics | | | | | |
| Gate Threshold Voltage ($V_{DS} = 10 \text{ Vdc}$, $I_D = 662 \mu\text{Adc}$) | $V_{GS(\text{th})}$ | 0.9 | 1.7 | 2.4 | Vdc |
| Gate Quiescent Voltage ($V_{DD} = 50 \text{ Vdc}$, $I_D = 100 \text{ mA}$, Measured in Functional Test) | $V_{GS(Q)}$ | 1.7 | 2.4 | 3.2 | Vdc |
| Drain-Source On-Voltage ($V_{GS} = 10 \text{ Vdc}$, $I_D = 1.6 \text{ Adc}$) | $V_{DS(\text{on})}$ | — | 0.25 | — | Vdc |
| Dynamic Characteristics (1) | | | | | |
| Reverse Transfer Capacitance ($V_{DS} = 50 \text{ Vdc} \pm 30 \text{ mV(rms)} \text{ ac} @ 1 \text{ MHz}$, $V_{GS} = 0 \text{ Vdc}$) | C_{rss} | — | 0.46 | — | pF |
| Output Capacitance ($V_{DS} = 50 \text{ Vdc} \pm 30 \text{ mV(rms)} \text{ ac} @ 1 \text{ MHz}$, $V_{GS} = 0 \text{ Vdc}$) | C_{oss} | — | 352 | — | pF |
| Input Capacitance ($V_{DS} = 50 \text{ Vdc}$, $V_{GS} = 0 \text{ Vdc} \pm 30 \text{ mV(rms)} \text{ ac} @ 1 \text{ MHz}$) | C_{iss} | — | 695 | — | pF |
| Functional Tests (In Freescale Test Fixture, 50 ohm system) $V_{DD} = 50 \text{ Vdc}$, $I_{DQ} = 100 \text{ mA}$, $P_{out} = 275 \text{ W Peak}$ (27.5 W Avg.), $f = 1030 \text{ MHz}$, Pulse, 128 μsec Pulse Width, 10% Duty Cycle | | | | | |
| Power Gain | G_{ps} | 19 | 20.3 | 22 | dB |
| Drain Efficiency | η_D | 63 | 65.5 | — | % |
| Input Return Loss | IRL | — | -14 | -9 | dB |
| Typical Broadband Performance — 960-1215 MHz (In Freescale 960-1215 MHz Test Fixture, 50 ohm system) $V_{DD} = 50 \text{ Vdc}$, $I_{DQ} = 100 \text{ mA}$, $P_{out} = 250 \text{ W Peak}$ (25 W Avg.), $f = 960-1215 \text{ MHz}$, Pulse, 128 μsec Pulse Width, 10% Duty Cycle | | | | | |
| Power Gain | G_{ps} | — | 19.8 | — | dB |
| Drain Efficiency | η_D | — | 58 | — | % |

1. Part internally matched both on input and output.



| | | | |
|----------|----------------------------|----------|--|
| Z1 | 1.055" x 0.082" Microstrip | Z13 | 0.190" x 1.250" Microstrip |
| Z2 | 0.100" x 0.082" Microstrip | Z14, Z15 | 0.517" x 0.080" Microstrip |
| Z3 | 0.084" x 0.395" Microstrip | Z16 | 0.225" x 1.250" Microstrip |
| Z4 | 0.419" x 0.040" Microstrip | Z17 | 0.860" x 0.975" Microstrip |
| Z5 | 0.498" x 0.466" Microstrip | Z18 | 0.140" x 0.950" Microstrip |
| Z6 | 0.110" x 1.060" Microstrip | Z19 | 0.028" x 0.110" Microstrip |
| Z7 | 0.050" x 1.300" Microstrip | Z20 | 0.397" x 0.040" Microstrip |
| Z8 | 0.092" x 1.300" Microstrip | Z21 | 0.264" x 0.480" Microstrip |
| Z9 | 0.219" x 1.420" Microstrip | Z22 | 0.100" x 0.082" Microstrip |
| Z10 | 0.087" x 1.420" Microstrip | Z23 | 0.521" x 0.082" Microstrip |
| Z11, Z12 | 0.187" x 0.050" Microstrip | PCB | Arlon CuClad 250GX-0300-55-22, 0.030", $\epsilon_r = 2.55$ |

Figure 1. MMRF1008HR5(HSR5) Test Circuit Schematic

Table 5. MMRF1008HR5(HSR5) Test Circuit Component Designations and Values

| Part | Description | Part Number | Manufacturer |
|------------------|---|----------------------|--------------|
| C1, C4, C5 | 1.5 pF Chip Capacitors | ATC100B1R5BT500XT | ATC |
| C2, C7, C11, C13 | 2.2 μ F, 100 V Chip Capacitors | G2225X7R225KT3AB | ATC |
| C3, C6, C10, C12 | 33 pF Chip Capacitors | ATC100B330JT500XT | ATC |
| C8 | 22 μ F, 25 V Chip Capacitor | TPSD226M025R0200 | AVX |
| C9 | 9.1 pF Chip Capacitor | ATC100B9R1CT500XT | ATC |
| C14, C15 | 470 μ F, 63 V Electrolytic Capacitors | MCGPA63V477M13X26-RH | Multicomp |
| R1, R2, R3, R4 | 0 Ω , 3.5 A Chip Resistors | CRCW12060000Z0EA | Vishay |

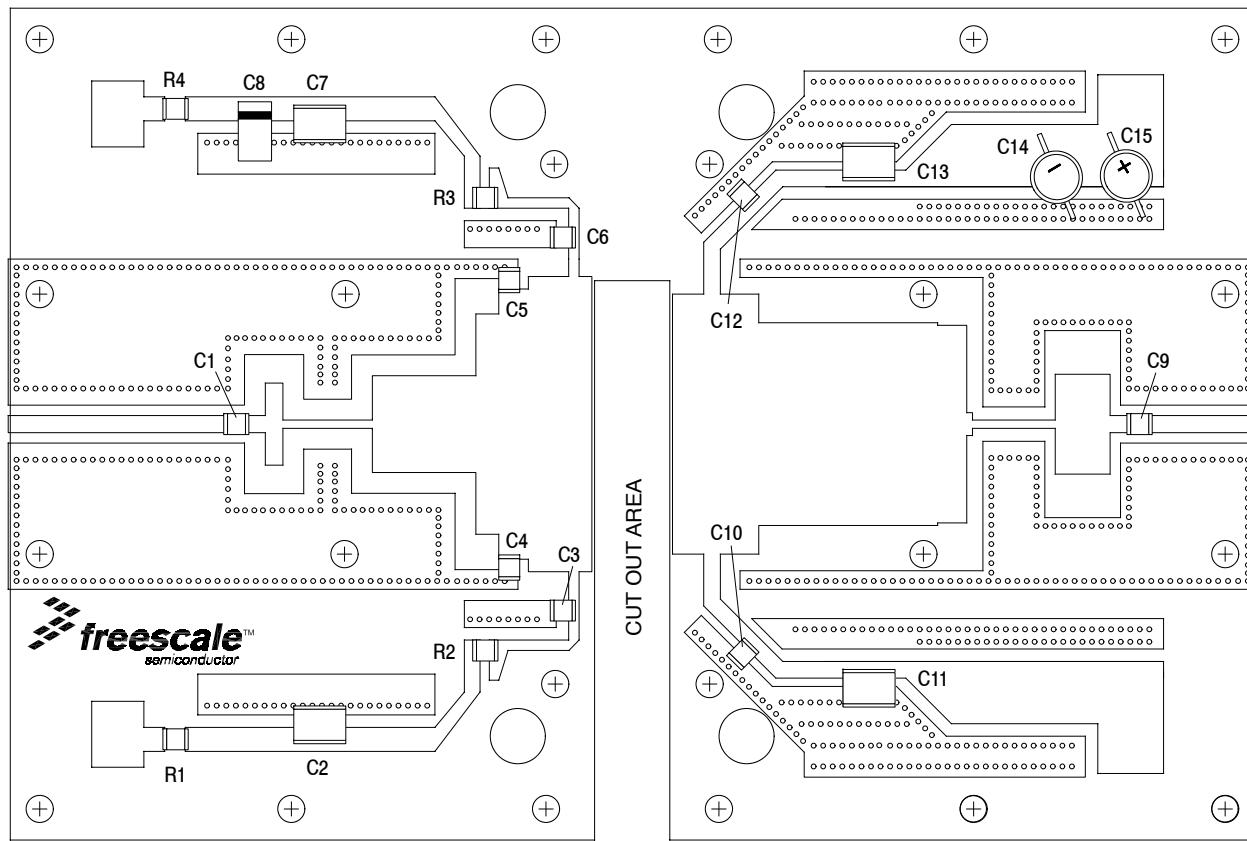


Figure 2. MMRF1008HR5(HSR5) Test Circuit Component Layout

TYPICAL CHARACTERISTICS

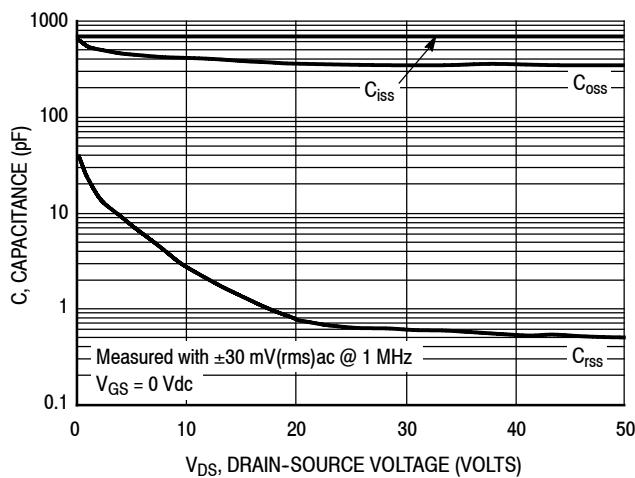


Figure 3. Capacitance versus Drain-Source Voltage

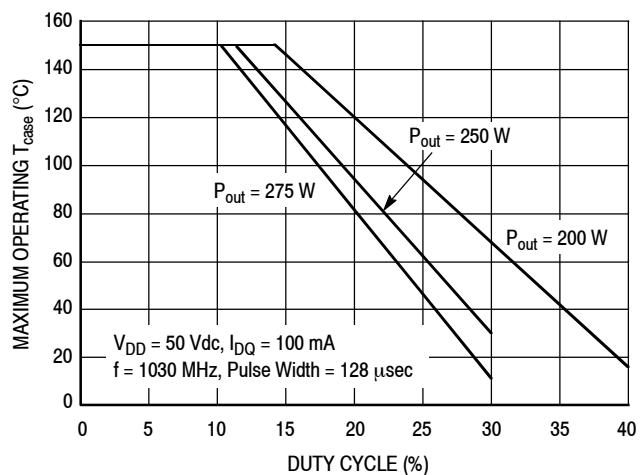


Figure 4. Safe Operating Area

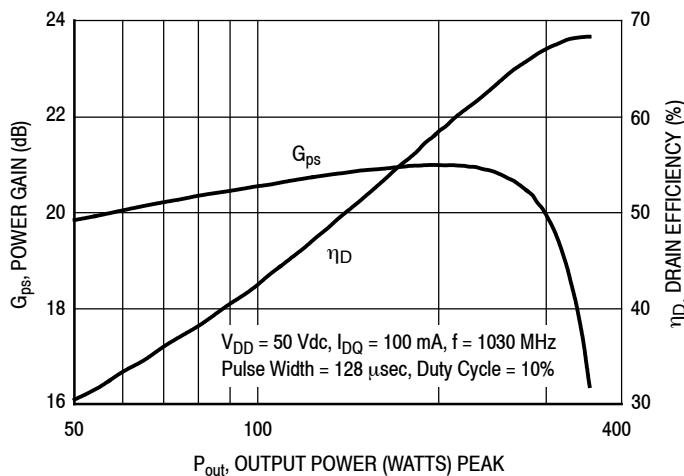


Figure 5. Power Gain and Drain Efficiency versus Output Power

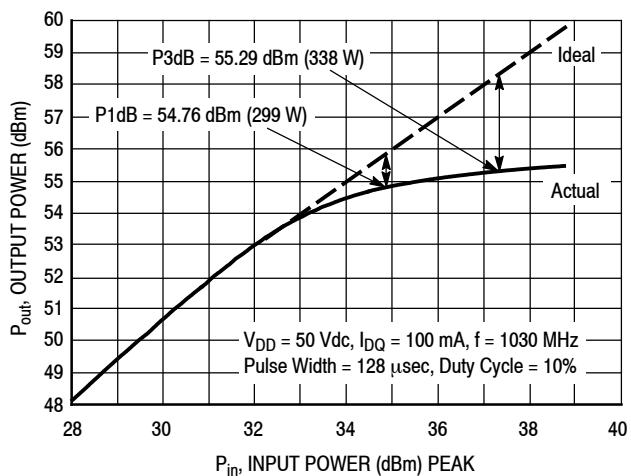


Figure 6. Output Power versus Input Power

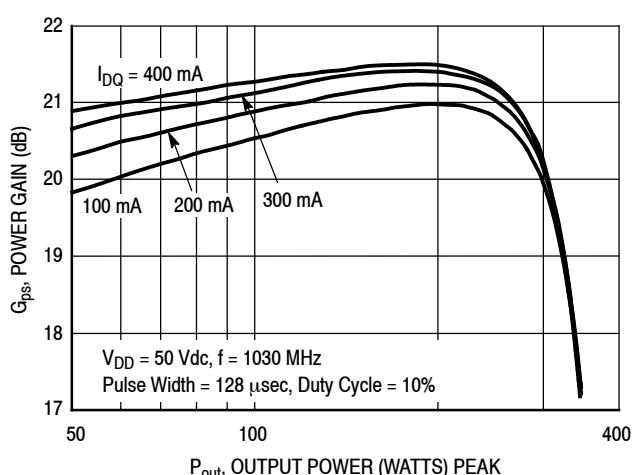


Figure 7. Power Gain versus Output Power

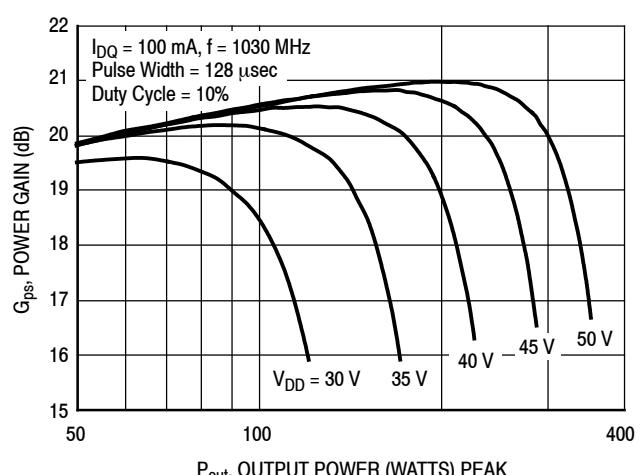


Figure 8. Power Gain versus Output Power

TYPICAL CHARACTERISTICS

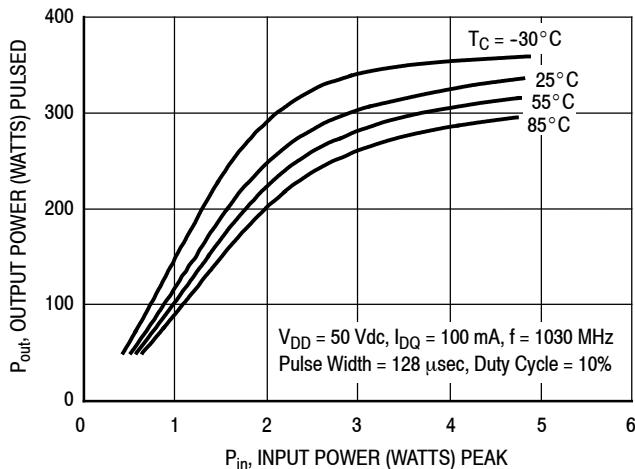


Figure 9. Output Power versus Input Power

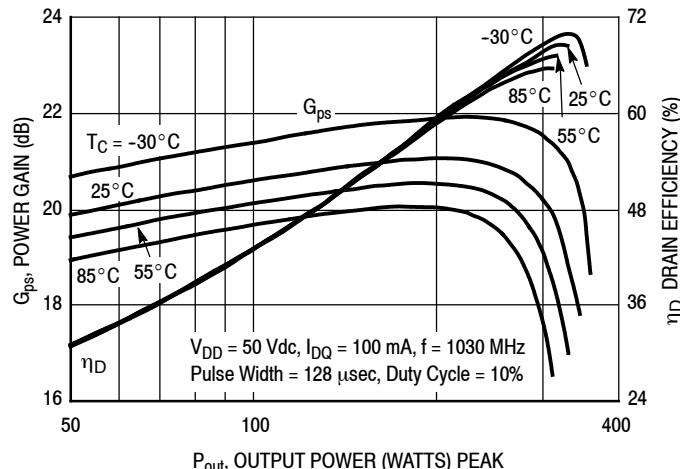
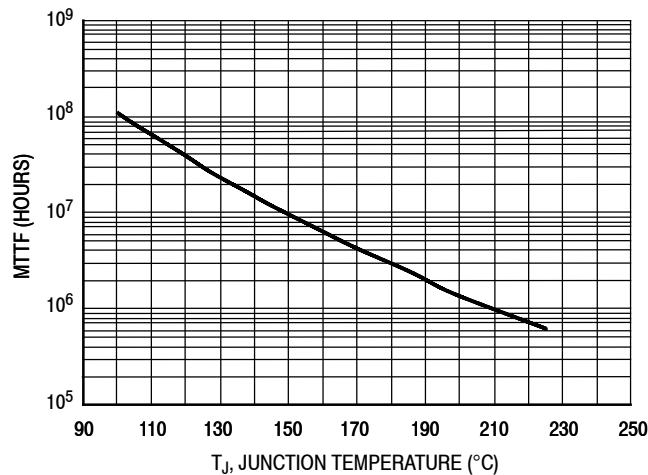


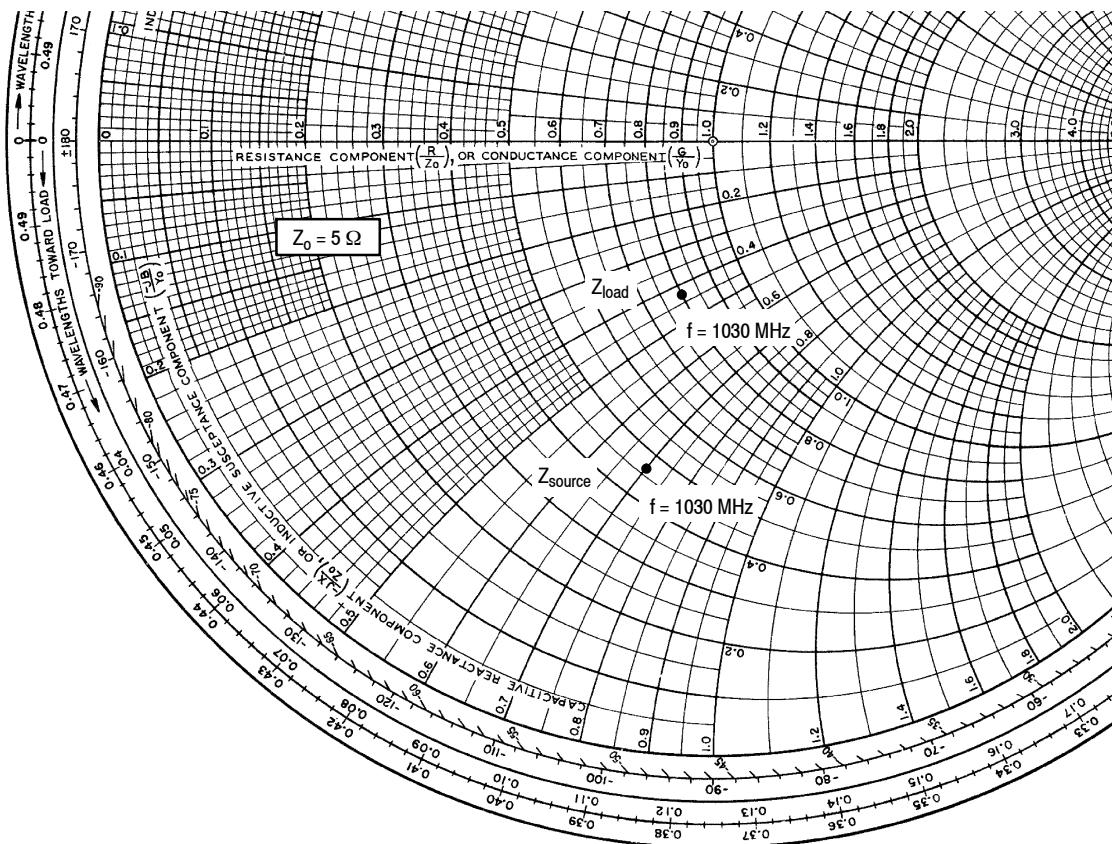
Figure 10. Power Gain and Drain Efficiency versus Output Power



This above graph displays calculated MTTF in hours when the device is operated at $V_{DD} = 50 \text{ Vdc}$, $P_{out} = 275 \text{ W Peak}$, Pulse Width = 128 μsec , Duty Cycle = 10%, and $\eta_D = 65.5\%$.

MTTF calculator available at <http://www.freescale.com/rf>. Select Software & Tools/Development Tools/Calculators to access MTTF calculators by product.

Figure 11. MTTF versus Junction Temperature



$V_{DD} = 50 \text{ Vdc}$, $I_{DQ} = 100 \text{ mA}$, $P_{\text{out}} = 275 \text{ W Peak}$

| f MHz | Z_{source} Ω | Z_{load} Ω |
|------------|---------------------------------|-------------------------------|
| 1030 | $2.30 - j3.51$ | $4.0 - j2.14$ |

Z_{source} = Test circuit impedance as measured from gate to ground.

Z_{load} = Test circuit impedance as measured from drain to ground.

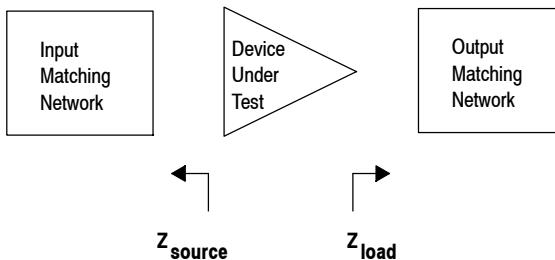


Figure 12. Series Equivalent Source and Load Impedance

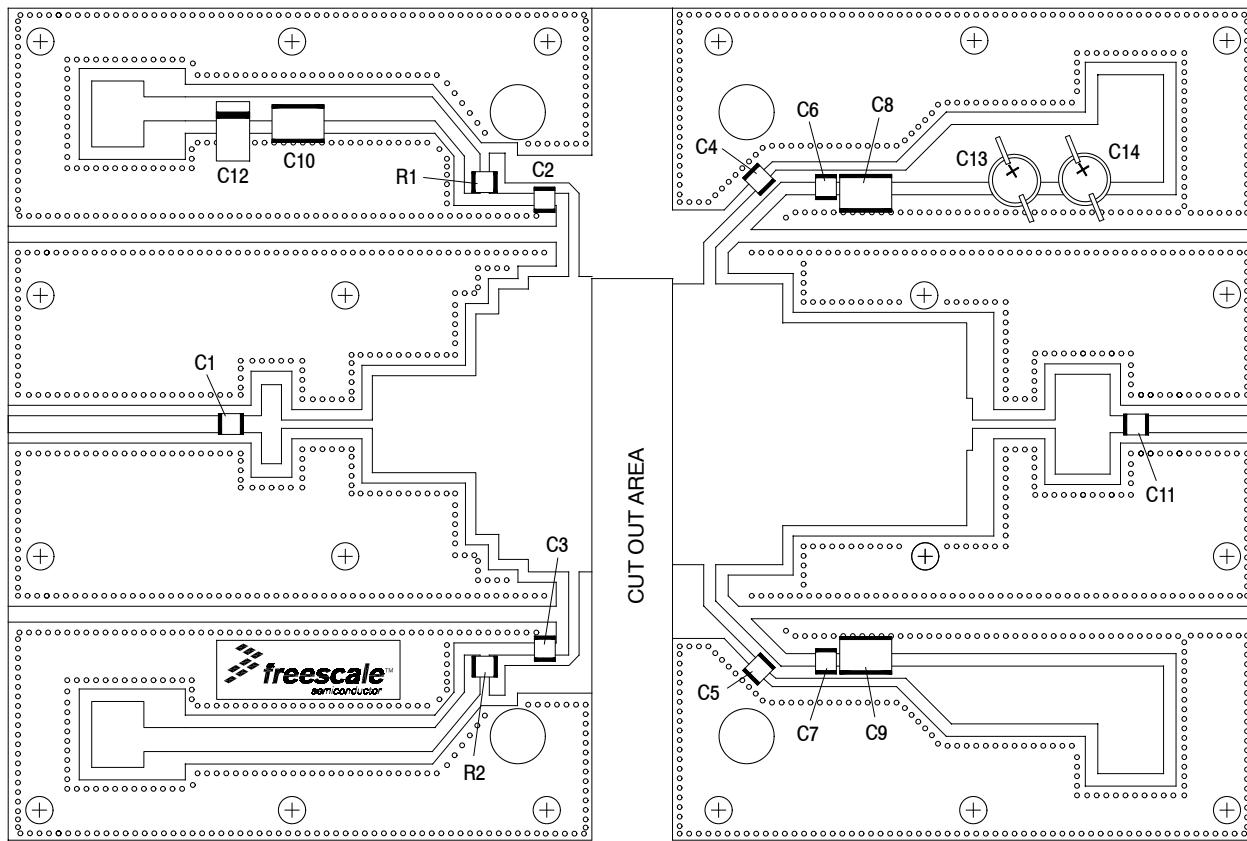


Figure 13. MMRF1008HR5(HSR5) Test Circuit Component Layout — 960-1215 MHz

Table 6. MMRF1008HR5(HSR5) Test Circuit Component Designations and Values — 960-1215 MHz

| Part | Description | Part Number | Manufacturer |
|----------------|---|----------------------|--------------|
| C1 | 2.7 pF Chip Capacitor | ATC100B2R7BT500XT | ATC |
| C2, C3, C4, C5 | 33 pF Chip Capacitors | ATC100B330JT500XT | ATC |
| C6, C7 | 1000 pF Chip Capacitors | ATC100B102JT50XT | ATC |
| C8, C9, C10 | 2.2 μ F, 100 V Chip Capacitors | G2225X7R225KT3AB | ATC |
| C11 | 9.1 pF Chip Capacitor | ATC100B9R1CT500XT | ATC |
| C12 | 22 μ F, 25 V Tantalum Capacitor | TPSD226M025R0200 | AVX |
| C13, C14 | 470 μ F, 63 V Electrolytic Capacitors | MCGPR63V477M13X26-RH | Multicomp |
| R1, R2 | 47 Ω , 1/4 W Chip Resistors | CRCW120647R0FKEA | Vishay |
| PCB | 0.030", $\epsilon_r = 2.55$ | AD255A | Arlon |

TYPICAL CHARACTERISTICS — 960-1215 MHz

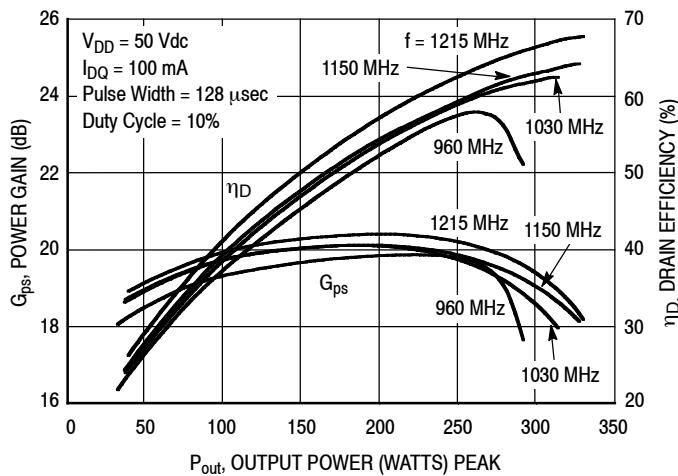


Figure 14. Power Gain and Drain Efficiency versus Output Power

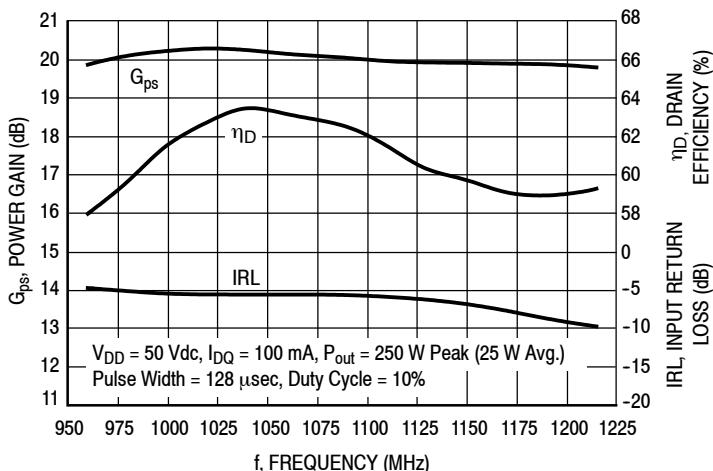
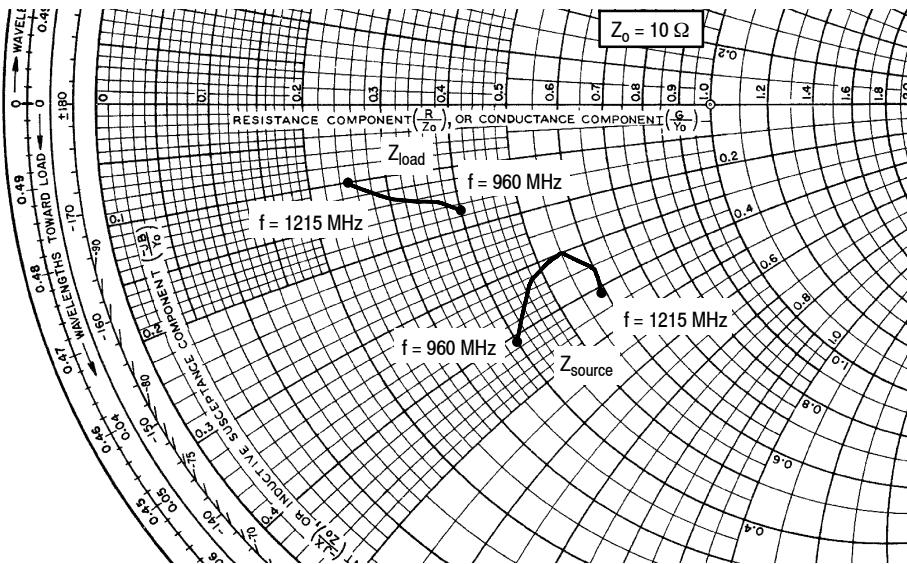


Figure 15. Broadband Performance @ $P_{out} = 250$ Watts Peak



$V_{DD} = 50 \text{ Vdc}, I_{DQ} = 100 \text{ mA}, P_{out} = 250 \text{ W Peak}$

| f MHz | Z_{source} Ω | Z_{load} Ω |
|------------|--------------------------|------------------------|
| 960 | $4.00 - j4.14$ | $3.96 - j1.70$ |
| 970 | $4.05 - j3.99$ | $3.90 - j1.67$ |
| 980 | $4.16 - j3.86$ | $3.83 - j1.66$ |
| 990 | $4.33 - j3.71$ | $3.75 - j1.66$ |
| 1000 | $4.49 - j3.57$ | $3.70 - j1.65$ |
| 1010 | $4.61 - j3.43$ | $3.68 - j1.62$ |
| 1020 | $4.66 - j3.33$ | $3.69 - j1.59$ |
| 1030 | $4.68 - j3.26$ | $3.69 - j1.54$ |
| 1040 | $4.72 - j3.20$ | $3.67 - j1.52$ |
| 1050 | $4.83 - j3.13$ | $3.59 - j1.53$ |
| 1060 | $5.02 - j3.06$ | $3.48 - j1.53$ |
| 1070 | $5.24 - j2.99$ | $3.38 - j1.53$ |
| 1080 | $5.42 - j2.96$ | $3.32 - j1.51$ |
| 1090 | $5.51 - j2.99$ | $3.30 - j1.47$ |

$V_{DD} = 50 \text{ Vdc}, I_{DQ} = 100 \text{ mA}, P_{out} = 250 \text{ W Peak}$

| f MHz | Z_{source} Ω | Z_{load} Ω |
|------------|--------------------------|------------------------|
| 1100 | $5.49 - j3.04$ | $3.32 - j1.43$ |
| 1110 | $5.47 - j3.07$ | $3.31 - j1.42$ |
| 1120 | $5.52 - j3.09$ | $3.24 - j1.40$ |
| 1130 | $5.68 - j3.13$ | $3.12 - j1.39$ |
| 1140 | $5.89 - j3.20$ | $2.99 - j1.36$ |
| 1150 | $6.06 - j3.32$ | $2.88 - j1.30$ |
| 1160 | $6.09 - j3.47$ | $2.83 - j1.23$ |
| 1170 | $5.98 - j3.60$ | $2.83 - j1.19$ |
| 1180 | $5.85 - j3.69$ | $2.80 - j1.15$ |
| 1190 | $5.78 - j3.76$ | $2.75 - j1.11$ |
| 1200 | $5.81 - j3.87$ | $2.65 - j1.07$ |
| 1210 | $5.89 - j4.02$ | $2.52 - j1.01$ |
| 1215 | $5.91 - j4.11$ | $2.47 - j0.97$ |

Z_{source} = Test circuit impedance as measured from gate to ground.

Z_{load} = Test circuit impedance as measured from drain to ground.

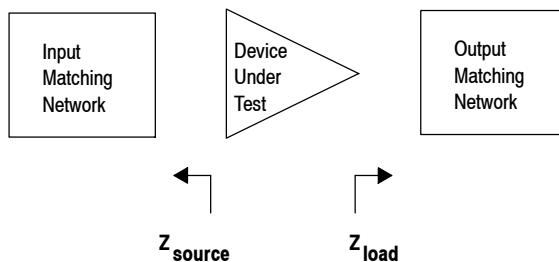
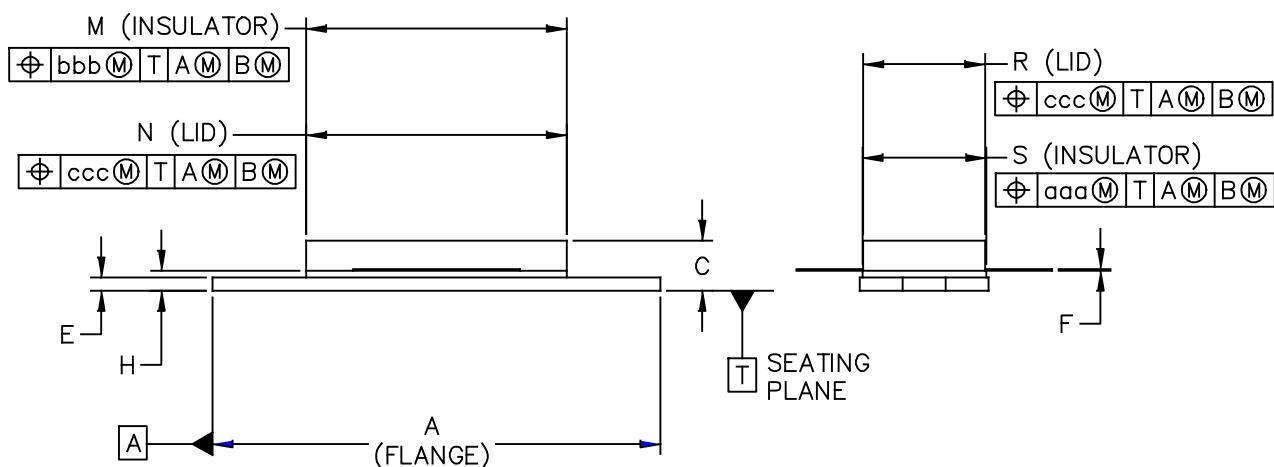
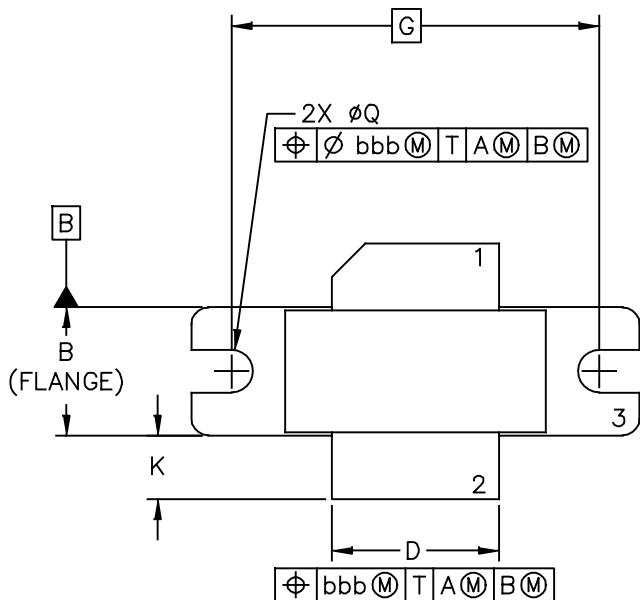


Figure 16. Series Equivalent Source and Load Impedance — 960-1215 MHz

PACKAGE DIMENSIONS



| | | |
|---|--------------------------|----------------------------|
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| TITLE: NI-780 | DOCUMENT NO: 98ASB15607C | REV: G |
| | CASE NUMBER: 465-06 | 31 MAR 2005 |
| | STANDARD: NON-JEDEC | |

MMRF1008HR5 MMRF1008HSR5

NOTES:

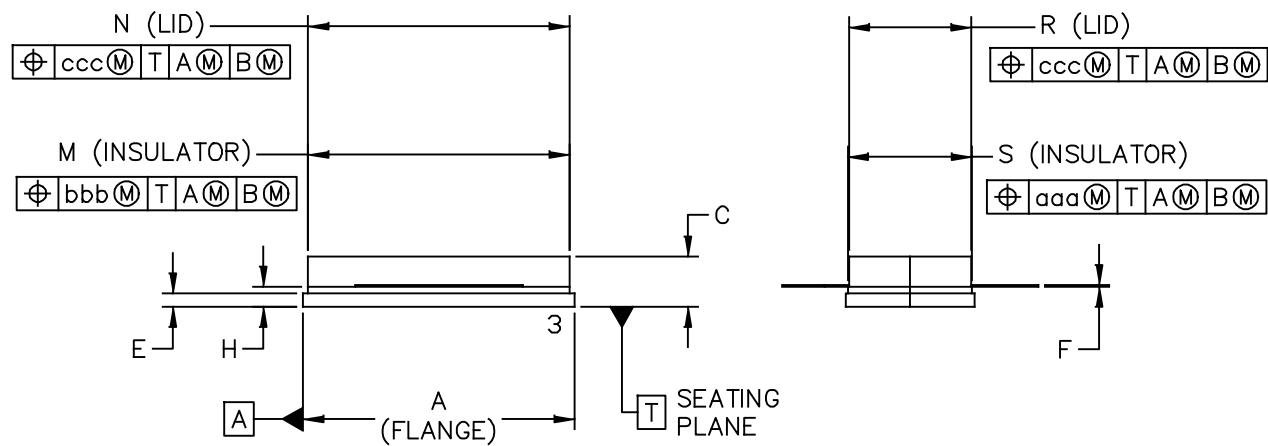
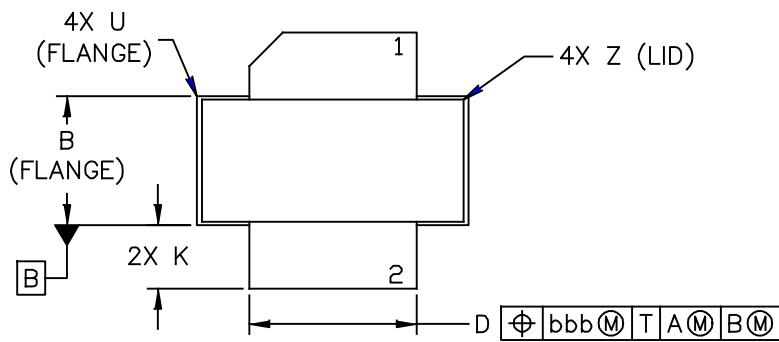
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M-1994.
2. CONTROLLING DIMENSION: INCH.
3. DELETED
4. DIMENSION H IS MEASURED .030 (.762) AWAY FROM PACKAGE BODY.

STYLE 1:

- PIN 1. DRAIN
2. GATE
3. SOURCE

| DIM | INCH | | MILLIMETER | | DIM | INCH | | MILLIMETER | | | | | | |
|-----|-------|-----|------------|-------|-----|-------|-----|------------|------|------|------|-------|------|---|
| | MIN | MAX | MIN | MAX | | MIN | MAX | MIN | MAX | | | | | |
| A | 1.335 | — | 1.345 | 33.91 | — | 34.16 | R | .365 | — | .375 | 9.27 | — | 9.53 | |
| B | .380 | — | .390 | 9.65 | — | 9.91 | S | .365 | — | .375 | 9.27 | — | 9.52 | |
| C | .125 | — | .170 | 3.18 | — | 4.32 | aaa | — | .005 | — | — | 0.127 | — | — |
| D | .495 | — | .505 | 12.57 | — | 12.83 | bbb | — | .010 | — | — | 0.254 | — | — |
| E | .035 | — | .045 | 0.89 | — | 1.14 | ccc | — | .015 | — | — | 0.381 | — | — |
| F | .003 | — | .006 | 0.08 | — | 0.15 | — | — | — | — | — | — | — | — |
| G | 1.100 | BSC | | 27.94 | BSC | | — | — | — | — | — | — | — | — |
| H | .057 | — | .067 | 1.45 | — | 1.7 | — | — | — | — | — | — | — | — |
| K | .170 | — | .210 | 4.32 | — | 5.33 | — | — | — | — | — | — | — | — |
| M | .774 | — | .786 | 19.66 | — | 19.96 | — | — | — | — | — | — | — | — |
| N | .772 | — | .788 | 19.6 | — | 20 | — | — | — | — | — | — | — | — |
| Q | Ø118 | — | Ø138 | Ø3 | — | Ø3.51 | — | — | — | — | — | — | — | — |

| | | |
|---|--|----------------------------|
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| TITLE: NI-780 | DOCUMENT NO: 98ASB15607C CASE NUMBER: 465-06 STANDARD: NON-JEDEC | REV: G 31 MAR 2005 |
| | | |



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|---|---|----------------------------|
| TITLE: NI-780S | DOCUMENT NO: 98ASB16718C CASE NUMBER: 465A-06 STANDARD: NON-JEDEC | REV: H 31 MAR 2005 |

MMRF1008HR5 MMRF1008HSR5

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M-1994.
2. CONTROLLING DIMENSION: INCH.
3. DELETED
4. DIMENSION H IS MEASURED .030 (0.762) AWAY FROM PACKAGE BODY.

STYLE 1:

- PIN 1. DRAIN
2. GATE
3. SOURCE

| DIM | INCH | | MILLIMETER | | DIM | INCH | | MILLIMETER | | | | |
|-----|------|-----|------------|-------|-----|-------|-----|------------|------|---|---|-------|
| | MIN | MAX | MIN | MAX | | MIN | MAX | MIN | MAX | | | |
| A | .805 | — | .815 | 20.45 | — | 20.7 | U | — | .040 | — | — | 1.02 |
| B | .380 | — | .390 | 9.65 | — | 9.91 | Z | — | .030 | — | — | 0.76 |
| C | .125 | — | .170 | 3.18 | — | 4.32 | aaa | — | .005 | — | — | 0.127 |
| D | .495 | — | .505 | 12.57 | — | 12.83 | bbb | — | .010 | — | — | 0.254 |
| E | .035 | — | .045 | 0.89 | — | 1.14 | ccc | — | .015 | — | — | 0.381 |
| F | .003 | — | .006 | 0.08 | — | 0.15 | — | — | — | — | — | — |
| H | .057 | — | .067 | 1.45 | — | 1.7 | — | — | — | — | — | — |
| K | .170 | — | .210 | 4.32 | — | 5.33 | — | — | — | — | — | — |
| M | .774 | — | .786 | 19.61 | — | 20.02 | — | — | — | — | — | — |
| N | .772 | — | .788 | 19.61 | — | 20.02 | — | — | — | — | — | — |
| R | .365 | — | .375 | 9.27 | — | 9.53 | — | — | — | — | — | — |
| S | .365 | — | .375 | 9.27 | — | 9.52 | — | — | — | — | — | — |

| | | |
|---|---|----------------------------|
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| TITLE: NI-780S | DOCUMENT NO: 98ASB16718C CASE NUMBER: 465A-06 STANDARD: NON-JEDEC | REV: H 31 MAR 2005 |

PRODUCT DOCUMENTATION

Refer to the following documents to aid your design process.

Application Notes

- AN1955: Thermal Measurement Methodology of RF Power Amplifiers

Engineering Bulletins

- EB212: Using Data Sheet Impedances for RF LDMOS Devices

REVISION HISTORY

The following table summarizes revisions to this document.

| Revision | Date | Description |
|----------|-----------|---|
| 0 | Dec. 2013 | <ul style="list-style-type: none">• Initial Release of Data Sheet |

MMRF1008HR5 MMRF1008HSR5

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